- Up to 532 user I/Os
  - LVDS interfaces up to 840 Mbps transmitter (Tx), 875 Mbps Rx
  - Support for DDR2 SDRAM interfaces up to 200 MHz
  - Support for QDRII SRAM and DDR SDRAM up to 167 MHz
- Up to eight phase-locked loops (PLLs) per device
- Offered in commercial and industrial temperature grades

Device Resources

Table 1–1 lists Cyclone IV E device resources.

Table 1–1. Resources for the Cyclone IV E Device Family

Resources	EP4CE6	EP4CE10	EP4CE15	EP4CE22	EP4CE30	EP4CE40	EP4CE55	EP4CE75	EP4CE115
Logic elements (LEs)	6,272	10,320	15,408	22,320	28,848	39,600	55,856	75,408	114,480
Embedded memory (Kbits)	270	414	504	594	594	1,134	2,340	2,745	3,888
Embedded 18 × 18 multipliers	15	23	56	66	66	116	154	200	266
General-purpose PLLs	2	2	4	4	4	4	4	4	4
Global Clock Networks	10	10	20	20	20	20	20	20	20
User I/O Banks	8	8	8	8	8	8	8	8	8
Maximum user I/O *(1)*	179	179	343	153	532	532	374	426	528

Note to Table 1–1:

(1) The user I/Os count from pin-out files includes all general purpose I/O, dedicated clock pins, and dual purpose configuration pins. Transceiver pins and dedicated configuration pins are not included in the pin count.

Package Matrix

Table 1–3 lists Cyclone IV E device package offerings.

Table 1–3. Package Offerings for the Cyclone IV E Device Family (1), (2)

Package	E144		M164		M256		U256		F256		F324		U484		F484		F780	
Size (mm)	22 × 22		8 × 8		9 x 9		14 × 14		17 × 17		19 x 19		19 × 19		23 × 23		29 × 29	
Pitch (mm)	0.5		0.5		0.5		0.8		1.0		1.0		0.8		1.0		1.0	
Device	User I/O	LVDS (3)	User I/O	LVDS (3)	User I/O	LVDS (3)	User I/O	LVDS (3)	User I/O	LVDS (3)	User I/O	LVDS (3)	User I/O	LVDS (3)	User I/O	LVDS (3)	User I/O	LVDS (3)
EP4CE6	91	21	—	—	—	—	179	66	179	66	—	—	—	—	—	—	—	—
EP4CE10	91	21	—	—	—	—	179	66	179	66	—	—	—	—	—	—	—	—
EP4CE15	81	18	89	21	165	53	165	53	165	53	—	—	—	—	343	137	—	—
EP4CE22	79	17	—	—	—	—	153	52	153	52	—	—	—	—	—	—	—	—
EP4CE30	—	—	—	—	—	—	—	—	—	—	193	68	—	—	328	124	532	224
EP4CE40	—	—	—	—	—	—	—	—	—	—	193	68	328	124	328	124	532	224
EP4CE55	—	—	—	—	—	—	—	—	—	—	—	—	324	132	324	132	374	160
EP4CE75	—	—	—	—	—	—	—	—	—	—	—	—	292	110	292	110	426	178
EP4CE115	—	—	—	—	—	—	—	—	—	—	—	—	—	—	280	103	528	230

Notes to Table 1–3:

(1) The E144 package has an exposed pad at the bottom of the package. This exposed pad is a ground pad that must be connected to the ground plane of your PCB. Use this exposed pad for electrical connectivity and not for thermal purposes.

(2) Use the Pin Migration View window in Pin Planner of the Quartus II software to verify the pin migration compatibility when you perform device migration. For more information, refer to the *I/O Management* chapter in volume 2 of the *Quartus II Handbook*.

(3) This includes both dedicated and emulated LVDS pairs. For more information, refer to the *I/O Features in Cyclone IV Devices* chapter.

Cyclone IV Device Family Speed Grades

Table 1–5 lists the Cyclone IV GX devices speed grades.

Table 1–5. Speed Grades for the Cyclone IV GX Device Family

Device	F169	F324	F484	F672	F896
EP4CGX15	C6, C7, C8, I7	—	—	—	—
EP4CGX22	C6, C7, C8, I7	C6, C7, C8, I7	—	—	—
EP4CGX30	C6, C7, C8, I7	C6, C7, C8, I7	C6, C7, C8, I7	—	—
EP4CGX50	—	—	C6, C7, C8, I7	C6, C7, C8, I7	—
EP4CGX75	—	—	C6, C7, C8, I7	C6, C7, C8, I7	—
EP4CGX110	—	—	C7, C8, I7	C7, C8, I7	C7, C8, I7
EP4CGX150	—	—	C7, C8, I7	C7, C8, I7	C7, C8, I7

Table 1–6 lists the Cyclone IV E devices speed grades.

Table 1–6. Speed Grades for the Cyclone IV E Device Family *(1), (2)*

Device	E144	M164	M256	U256	F256	F324	U484	F484	F780
EP4CE6	C8L, C9L, I8L C6, C7, C8, I7, A7	—	—	I7N	C8L, C9L, I8L C6, C7, C8, I7, A7	—	—	—	—
EP4CE10	C8L, C9L, I8L C6, C7, C8, I7, A7	—	—	I7N	C8L, C9L, I8L C6, C7, C8, I7, A7	—	—	—	—
EP4CE15	C8L, C9L, I8L C6, C7, C8, I7	I7N	C7N, I7N	I7N	C8L, C9L, I8L C6, C7, C8, I7, A7	—	—	C8L, C9L, I8L C6, C7, C8, I7, A7	—
EP4CE22	C8L, C9L, I8L C6, C7, C8, I7, A7	—	—	I7N	C8L, C9L, I8L C6, C7, C8, I7, A7	—	—	—	—
EP4CE30	—	—	—	—	—	A7N	—	C8L, C9L, I8L C6, C7, C8, I7, A7	C8L, C9L, I8L C6, C7, C8, I7
EP4CE40	—	—	—	—	—	A7N	I7N	C8L, C9L, I8L C6, C7, C8, I7, A7	C8L, C9L, I8L C6, C7, C8, I7
EP4CE55	—	—	—	—	—	—	I7N	C8L, C9L, I8L C6, C7, C8, I7	C8L, C9L, I8L C6, C7, C8, I7
EP4CE75	—	—	—	—	—	—	I7N	C8L, C9L, I8L C6, C7, C8, I7	C8L, C9L, I8L C6, C7, C8, I7
EP4CE115	—	—	—	—	—	—	—	C8L, C9L, I8L C7, C8, I7	C8L, C9L, I8L C7, C8, I7

Notes to Table 1–6:

(1) C8L, C9L, and I8L speed grades are applicable for the 1.0-V core voltage.

(2) C6, C7, C8, I7, and A7 speed grades are applicable for the 1.2-V core voltage.

Table 4–1 lists the number of embedded multipliers and the multiplier modes that can be implemented in each Cyclone IV device.

Table 4–1. Number of Embedded Multipliers in Cyclone IV Devices

Device Family	Device	Embedded Multipliers	9 × 9 Multipliers (1)	18 × 18 Multipliers (1)
Cyclone IV GX	EP4CGX15	0	0	0
	EP4CGX22	40	80	40
	EP4CGX30	80	160	80
	EP4CGX50	140	280	140
	EP4CGX75	198	396	198
	EP4CGX110	280	560	280
	EP4CGX150	360	720	360
Cyclone IV E	EP4CE6	15	30	15
	EP4CE10	23	46	23
	EP4CE15	56	112	56
	EP4CE22	66	132	66
	EP4CE30	66	132	66
	EP4CE40	116	232	116
	EP4CE55	154	308	154
	EP4CE75	200	400	200
	EP4CE115	266	532	266

Note to Table 4–1:

(1) These columns show the number of 9 × 9 or 18 × 18 multipliers for each device.

In addition to the embedded multipliers in Cyclone IV devices, you can implement soft multipliers by using the M9K memory blocks as look-up tables (LUTs). The LUTs contain partial results from the multiplication of input data with coefficients that implement variable depth and width high-performance soft multipliers for low-cost, high-volume DSP applications. The availability of soft multipliers increases the number of available multipliers in the device.

For more information about M9K memory blocks, refer to the *Memory Blocks in Cyclone IV Devices* chapter.

For more information about soft multipliers, refer to *AN 306: Implementing Multipliers in FPGA Devices*.

Architecture

Each embedded multiplier consists of the following elements:

- Multiplier stage
- Input and output registers
- Input and output interfaces

5. Clock Networks and PLLs in Cyclone IV Devices

This chapter describes the hierarchical clock networks and phase-locked loops (PLLs) with advanced features in the Cyclone® IV device family. It includes details about the ability to reconfigure the PLL counter clock frequency and phase shift in real time, allowing you to sweep PLL output frequencies and dynamically adjust the output clock phase shift.

The Quartus® II software enables the PLLs and their features without external devices.

This chapter contains the following sections:

Clock Networks

The Cyclone IV GX device provides up to 12 dedicated clock pins (`CLK[15..4]`) that can drive the global clocks (GCLKs). Cyclone IV GX devices support four dedicated clock pins on each side of the device except the left side. These clock pins can drive up to 30 GCLKs.

The Cyclone IV E device provides up to 15 dedicated clock pins (`CLK[15..1]`) that can drive up to 20 GCLKs. Cyclone IV E devices support three dedicated clock pins on the left side and four dedicated clock pins on the top, right, and bottom sides of the device except EP4CE6 and EP4CE10 devices. EP4CE6 and EP4CE10 devices only support three dedicated clock pins on the left side and four dedicated clock pins on the right side of the device.

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Table 5–3. GCLK Network Connections for Cyclone IV E Devices (1) (Part 3 of 3)

GCLK Network Clock Sources	GCLK Networks																			
	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
DPCLK2 (4) CDPCLK1, or CDPCLK2 (2), (5)	—	—	—	✓	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
DPCLK5 (4) DPCLK7 (2)	—	—	—	—	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—	—
DPCLK4 (4) DPCLK6 (2)	—	—	—	—	—	—	✓	—	—	—	—	—	—	—	—	—	—	—	—	—
DPCLK6 (4) CDPCLK5, or CDPCLK6 (2), (5)	—	—	—	—	—	—	—	✓	—	—	—	—	—	—	—	—	—	—	—	—
DPCLK3 (4) CDPCLK4, or CDPCLK3 (2), (5)	—	—	—	—	—	—	—	—	✓	✓	—	—	—	—	—	—	—	—	—	—
DPCLK8	—	—	—	—	—	—	—	—	—	—	✓	—	—	—	—	—	—	—	—	—
DPCLK11	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	—	—	—	—	—	—
DPCLK9	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	—	—	—	—	—
DPCLK10	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	✓	—	—	—	—	—
DPCLK5	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	—	—
DPCLK2	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—	—
DPCLK4	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	—	—
DPCLK3	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	✓	✓

Notes to Table 5–3:

(1) EP4CE6 and EP4CE10 devices only have GCLK networks 0 to 9.

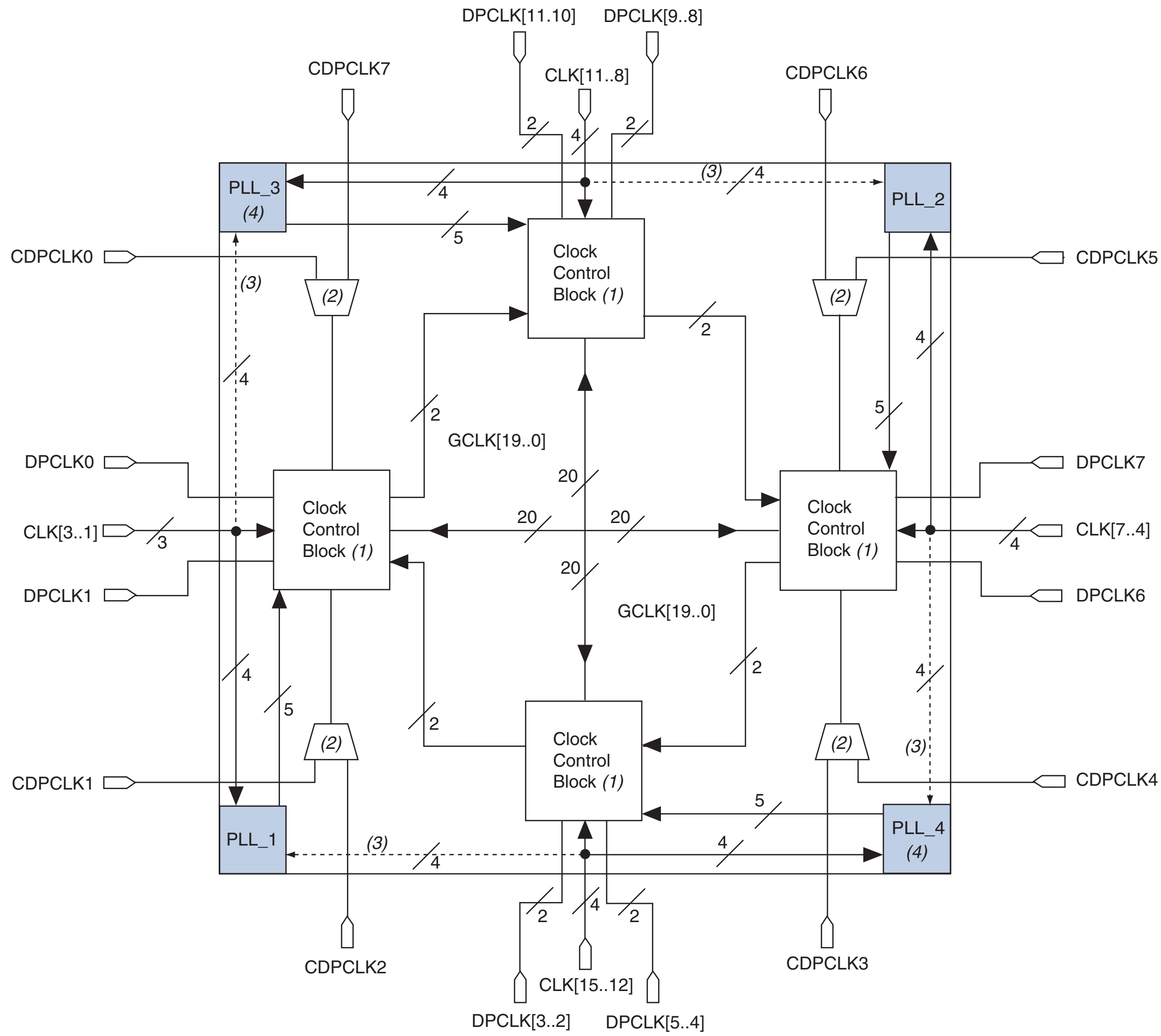
(2) These pins apply to all Cyclone IV E devices except EP4CE6 and EP4CE10 devices.

(3) EP4CE6 and EP4CE10 devices only have PLL_1 and PLL_2.

(4) This pin applies only to EP4CE6 and EP4CE10 devices.

(5) Only one of the two CDPCLK pins can feed the clock control block. You can use the other pin as a regular I/O pin.

Figure 5–4. Clock Networks and Clock Control Block Locations in Cyclone IV E Devices



Notes to Figure 5–4:

(1) There are five clock control blocks on each side.

(2) Only one of the corner `CDPCLK` pins in each corner can feed the clock control block at a time. You can use the other `CDPCLK` pins as general-purpose I/O (GPIO) pins.

(3) Dedicated clock pins can feed into this PLL. However, these paths are not fully compensated.

(4) `PLL_3` and `PLL_4` are not available in EP4CE6 and EP4CE10 devices.

The inputs to the clock control blocks on each side of the Cyclone IV GX device must be chosen from among the following clock sources:

- Four clock input pins
- Ten PLL counter outputs (five from each adjacent PLLs)
- Two, four, or six `DPCLK` pins from the top, bottom, and right sides of the device
- Five signals from internal logic

Each Cyclone IV I/O bank has a VREF bus to accommodate voltage-referenced I/O standards. Each `VREF` pin is the reference source for its V_{REF} group. If you use a V_{REF} group for voltage-referenced I/O standards, connect the `VREF` pin for that group to the appropriate voltage level. If you do not use all the V_{REF} groups in the I/O bank for voltage-referenced I/O standards, you can use the `VREF` pin in the unused voltage-referenced groups as regular I/O pins. For example, if you have SSTL-2 Class I input pins in I/O bank 1 and they are all placed in the `VREFB1N[0]` group, `VREFB1N[0]` must be powered with 1.25 V, and the remaining `VREFB1N[1..3]` pins (if available) are used as I/O pins. If multiple V_{REF} groups are used in the same I/O bank, the `VREF` pins must all be powered by the same voltage level because the `VREF` pins are shorted together within the same I/O bank.

When `VREF` pins are used as regular I/Os, they have higher pin capacitance than regular user I/O pins. This has an impact on the timing if the pins are used as inputs and outputs.

For more information about `VREF` pin capacitance, refer to the pin capacitance section in the *Cyclone IV Device Datasheet* chapter.

For information about how to identify V_{REF} groups, refer to the Cyclone IV **Device Pin-Out** files or the **Quartus II Pin Planner** tool.

Table 6–4 and Table 6–5 summarize the number of `VREF` pins in each I/O bank for the Cyclone IV device family.

Table 6–4. Number of VREF Pins Per I/O Bank for Cyclone IV E Devices (Part 1 of 2)

Device	EP4CE6			EP4CE10			EP4CE15						EP4CE22			EP4CE30			EP4CE40				EP4CE55			EP4CE75			EP4CE115	
I/O Bank *(1)*	144-EQPF	256-UBGA	256-FBGA	144-EQPF	256-UBGA	256-FBGA	144-EQPF	164-MBGA	256-MBGA	256-UBGA	256-FBGA	484-FBGA	144-EQPF	256-UBGA	256-FBGA	324-FBGA	484-FBGA	780-FBGA	324-FBGA	484-UBGA	484-FBGA	780-FBGA	484-UBGA	484-FBGA	780-FBGA	484-UBGA	484-FBGA	780-FBGA	484-FBGA	780-FBGA
1	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3
2	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3
3	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3
4	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3
5	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3
6	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3
7	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3

Table 6–4. Number of VREF Pins Per I/O Bank for Cyclone IV E Devices (Part 2 of 2)

Device	EP4CE6			EP4CE10			EP4CE15						EP4CE22			EP4CE30			EP4CE40				EP4CE55			EP4CE75			EP4CE115	
I/O Bank *(1)*	144-EQPF	256-UBGA	256-FBGA	144-EQPF	256-UBGA	256-FBGA	144-EQPF	164-MBGA	256-MBGA	256-UBGA	256-FBGA	484-FBGA	144-EQPF	256-UBGA	256-FBGA	324-FBGA	484-FBGA	780-FBGA	324-FBGA	484-UBGA	484-FBGA	780-FBGA	484-UBGA	484-FBGA	780-FBGA	484-UBGA	484-FBGA	780-FBGA	484-FBGA	780-FBGA
8	1	1	1	1	1	1	2	2	2	2	2	2	1	1	1	4	4	4	4	4	4	4	2	2	2	3	3	3	3	3

Note to Table 6–4:

(1) User I/O pins are used as inputs or outputs; clock input pins are used as inputs only; clock output pins are used as output only.

Table 6–5. Number of VREF Pins Per I/O Bank for Cyclone IV GX Devices

Device	4CGX15	4CGX22		4CGX30			4CGX50		4CGX75		4CGX110			4CGX150		
I/O Bank *(1)*	169-FBGA	169-FBGA	324-FBGA	169-FBGA	324-FBGA	484-FBGA	484-FBGA	672-FBGA	484-FBGA	672-FBGA	484-FBGA	672-FBGA	896-FBGA	484-FBGA	672-FBGA	896-FBGA
3	1	1		1		3	3		3		3			3		
4	1	1		1		3	3		3		3			3		
5	1	1		1		3	3		3		3			3		
6	1	1		1		3	3		3		3			3		
7	1	1		1		3	3		3		3			3		
8 *(2)*	1	1		1		3	3		3		3			3		

Notes to Table 6–5:

(1) User I/O pins are used as inputs or outputs; clock input pins are used as inputs only; clock output pins are used as output only.

(2) Bank 9 does not have `VREF` pin. If input pins with `VREF` I/O standards are used in bank 9 during user mode, it shares the `VREF` pin in bank 8.

Each Cyclone IV I/O bank has its own `VCCIO` pins. Each I/O bank can support only one V_{CCIO} setting from among 1.2, 1.5, 1.8, 2.5, 3.0, or 3.3 V. Any number of supported single-ended or differential standards can be simultaneously supported in a single I/O bank, as long as they use the same V_{CCIO} levels for input and output pins.

Table 6–8 and Table 6–9 summarize the total number of supported row and column differential channels in the Cyclone IV device family.

Table 6–8. Cyclone IV E I/O and Differential Channel Count

Device	EP4CE6			EP4CE10			EP4CE15						EP4CE22			EP4CE30			EP4CE40				EP4CE55			EP4CE75			EP4CE115	
Numbers of Differential Channels (1), (2)	144-EQPF	256-UBGA	256-FBGA	144-EQPF	256-UBGA	256-FBGA	144-EQPF	164-MBGA	256-MBGA	256-UBGA	256-FBGA	484-FBGA	144-EQPF	256-UBGA	256-FBGA	324-FBGA	484-FBGA	780-FBGA	324-FBGA	484-UBGA	484-FBGA	780-FBGA	484-UBGA	484-FBGA	780-FBGA	484-UBGA	484-FBGA	780-FBGA	484-FBGA	780-FBGA
User I/O (3)	91	179	179	91	179	179	81	89	165	165	165	343	79	153	153	193	328	532	193	328	328	532	324	324	374	292	292	426	280	528
User I/O Banks	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8	8
LVDS (4), (6)	8	23	23	8	23	23	6	8	21	21	21	67	7	20	20	30	60	112	30	60	60	112	62	62	70	54	54	79	50	103
Emulated LVDS (5), (6)	13	43	43	13	43	43	12	13	32	32	32	70	10	32	32	38	64	112	38	64	64	112	70	70	90	56	56	99	53	127

Notes to Table 6–8:

(1) User I/O pins are used as inputs or outputs; clock input pins are used as inputs only; clock output pins are used as output only.

(2) For differential pad placement guidelines, refer to "Pad Placement" on page 6–23.

(3) The I/O pin count includes all GPIOs, dedicated clock pins, and dual-purpose configuration pins. Dedicated configuration pins are not included in the pin count.

(4) The true LVDS count includes all LVDS I/O pairs, differential clock input and clock output pins in row I/O banks 1, 2, 5, and 6.

(5) The emulated LVDS count includes all LVDS I/O pairs, differential clock input and clock output pins in column I/O banks 3, 4, 7, and 8.

(6) LVDS input and output buffers are sharing the same p and n pins. One LVDS I/O channel can only be either transmitter or receiver at a time.

Table 7–2 lists the number of DQS or DQ groups supported on each side of the Cyclone IV E device.

Table 7–2. Cyclone IV E Device DQS and DQ Bus Mode Support for Each Side of the Device (Part 1 of 3)

Device	Package	Side	Number ×8 Groups	Number ×9 Groups	Number ×16 Groups	Number ×18 Groups	Number ×32 Groups	Number ×36 Groups
EP4CE6 EP4CE10	144-pin EQFP	Left	0	0	0	0	—	—
		Right	0	0	0	0	—	—
		Bottom (1), (3)	1	0	0	0	—	—
		Top (1), (4)	1	0	0	0	—	—
	256-pin UBGA	Left (1)	1	1	0	0	—	—
		Right (2)	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
	256-pin FBGA	Left (1)	1	1	0	0	—	—
		Right (2)	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
EP4CE15	144-pin EQFP	Left	0	0	0	0	—	—
		Right	0	0	0	0	—	—
		Bottom (1), (3)	1	0	0	0	—	—
		Top (1), (4)	1	0	0	0	—	—
	164-pin MBGA	Left	0	0	0	0	—	—
		Right	0	0	0	0	—	—
		Bottom (1), (3)	1	0	0	0	—	—
		Top (1), (4)	1	0	0	0	—	—
	256-pin MBGA	Left	1	1	0	0	—	—
		Right	1	1	0	0	—	—
		Bottom (1), (3)	2	2	1	1	—	—
		Top (1), (4)	2	2	1	1	—	—
	256-pin UBGA	Left (1)	1	1	0	0	—	—
		Right (2)	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
	256-pin FBGA	Left (1)	1	1	0	0	—	—
		Right (2)	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
	484-pin FBGA	Left	4	4	2	2	1	1
		Right	4	4	2	2	1	1
		Bottom	4	4	2	2	1	1
		Top	4	4	2	2	1	1

Power-On Reset (POR) Circuit

The POR circuit keeps the device in reset state until the power supply voltage levels have stabilized during device power up. After device power up, the device does not release nSTATUS until V_{CCINT}, V_{CCA}, and V_{CCIO} (for I/O banks in which the configuration and JTAG pins reside) are above the POR trip point of the device. V_{CCINT} and V_{CCA} are monitored for brown-out conditions after device power up.

☞ V_{CCA} is the analog power to the phase-locked loop (PLL).

In some applications, it is necessary for a device to wake up very quickly to begin operation. Cyclone IV devices offer the fast POR time option to support fast wake-up time applications. The fast POR time option has stricter power-up requirements when compared with the standard POR time option. You can select either the fast option or the standard POR option with the MSEL pin settings.

☞ If your system exceeds the fast or standard POR time, you must hold nCONFIG low until all the power supplies are stable.

For more information about the POR specifications, refer to the *Cyclone IV Device Datasheet*.

For more information about the wake-up time and POR circuit, refer to the *Power Requirements for Cyclone IV Devices* chapter.

Configuration File Size

Table 8–2 lists the approximate uncompressed configuration file sizes for Cyclone IV devices. To calculate the amount of storage space required for multiple device configurations, add the file size of each device together.

Table 8–2. Uncompressed Raw Binary File (.rbf) Sizes for Cyclone IV Devices (Part 1 of 2)

Device		Data Size (bits)
Cyclone IV E	EP4CE6	2,944,088
	EP4CE10	2,944,088
	EP4CE15	4,086,848
	EP4CE22	5,748,552
	EP4CE30	9,534,304
	EP4CE40	9,534,304
	EP4CE55	14,889,560
	EP4CE75	19,965,752
	EP4CE115	28,571,696

You can use the Quartus II software with the APU and the appropriate configuration device programming adapter to program serial configuration devices. All serial configuration devices are offered in an 8- or 16-pin small outline integrated circuit (SOIC) package.

In production environments, serial configuration devices are programmed using multiple methods. Altera programming hardware or other third-party programming hardware is used to program blank serial configuration devices before they are mounted onto PCBs. Alternatively, you can use an on-board microprocessor to program the serial configuration device in-system by porting the reference C-based SRunner software driver provided by Altera.

A serial configuration device is programmed in-system by an external microprocessor with the SRunner software driver. The SRunner software driver is a software driver developed for embedded serial configuration device programming, which is easily customized to fit in different embedded systems. The SRunner software driver is able to read a Raw Programming Data (**.rpd**) file and write to serial configuration devices. The serial configuration device programming time, using the SRunner software driver, is comparable to the programming time with the Quartus II software.

For more information about the SRunner software driver, refer to *AN 418: SRunner: An Embedded Solution for Serial Configuration Device Programming* and the source code at the Altera website.

AP Configuration (Supported Flash Memories)

The AP configuration scheme is only supported in Cyclone IV E devices. In the AP configuration scheme, Cyclone IV E devices are configured using commodity 16-bit parallel flash memory. These external non-volatile configuration devices are industry standard microprocessor flash memories. The flash memories provide a fast interface to access configuration data. The speed up in configuration time is mainly due to the 16-bit wide parallel data bus, which is used to retrieve data from the flash memory.

Some of the smaller Cyclone IV E devices or package options do not support the AP configuration scheme. Table 8–9 lists the supported AP configuration scheme for each Cyclone IV E devices.

Table 8–9. Supported AP Configuration Scheme for Cyclone IV E Devices

Device	Package Options								
	E144	M164	M256	U256	F256	F324	U484	F484	F780
EP4CE6	—	—	—	—	—	—	—	—	—
EP4CE10	—	—	—	—	—	—	—	—	—
EP4CE15	—	—	—	—	—	—	—	✓	—
EP4CE22	—	—	—	—	—	—	—	—	—
EP4CE30	—	—	—	—	—	✓	—	✓	✓
EP4CE40	—	—	—	—	—	✓	✓	✓	✓
EP4CE55	—	—	—	—	—	—	✓	✓	✓
EP4CE75	—	—	—	—	—	—	✓	✓	✓
EP4CE115	—	—	—	—	—	—	—	✓	✓

Table 9–6 lists the estimated time for each CRC calculation with minimum and maximum clock frequencies for Cyclone IV devices.

Table 9–6. CRC Calculation Time

Device		Minimum Time (ms) (1)	Maximum Time (s) (2)
Cyclone IV E	EP4CE6 (3)	5	2.29
	EP4CE10 (3)	5	2.29
	EP4CE15 (3)	7	3.17
	EP4CE22 (3)	9	4.51
	EP4CE30 (3)	15	7.48
	EP4CE40 (3)	15	7.48
	EP4CE55 (3)	23	11.77
	EP4CE75 (3)	31	15.81
	EP4CE115 (3)	45	22.67
Cyclone IV GX	EP4CGX15	6	2.93
	EP4CGX22	12	5.95
	EP4CGX30	12	5.95
		34 (4)	17.34 (4)
	EP4CGX50	34	17.34
	EP4CGX75	34	17.34
	EP4CGX110	62	31.27
	EP4CGX150	62	31.27

Notes to Table 9–6:

(1) The minimum time corresponds to the maximum error detection clock frequency and may vary with different processes, voltages, and temperatures (PVT).

(2) The maximum time corresponds to the minimum error detection clock frequency and may vary with different PVT.

(3) Only applicable for device with 1.2-V core voltage

(4) Only applicable for the F484 device package.

Software Support

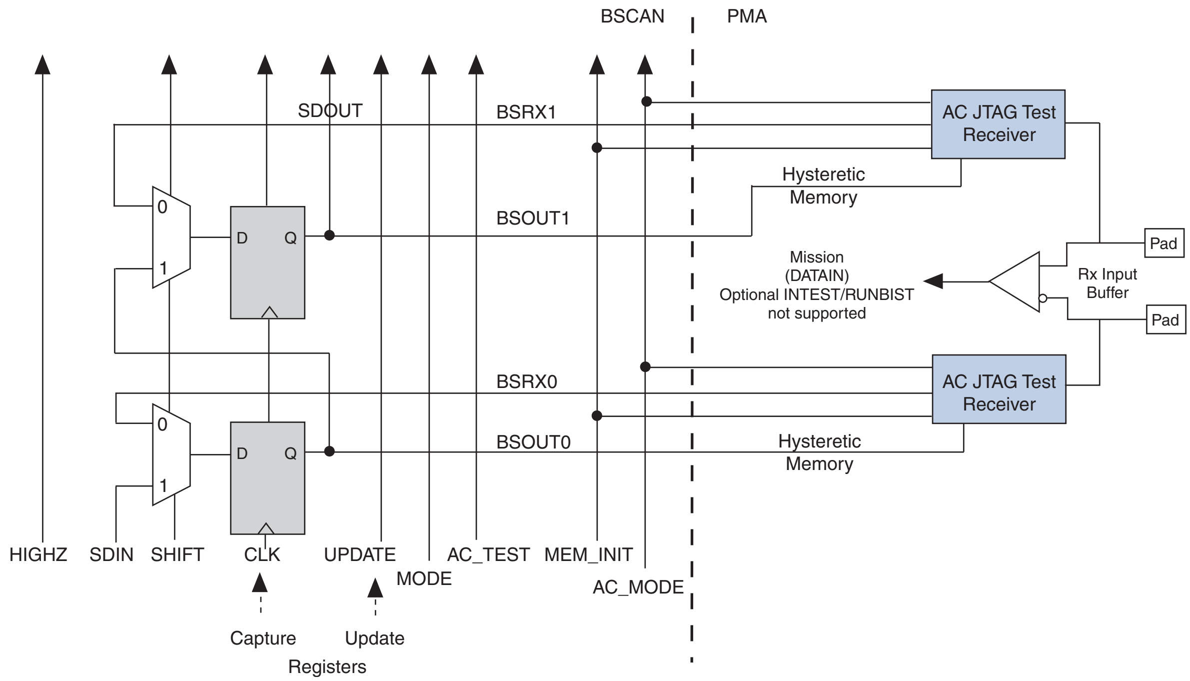
Enabling the CRC error detection feature in the Quartus II software generates the `CRC_ERROR` output to the optional dual purpose `CRC_ERROR` pin.

To enable the error detection feature using CRC, perform the following steps:

1. Open the Quartus II software and load a project using Cyclone IV devices.
2. On the Assignments menu, click **Settings**. The **Settings** dialog box appears.
3. In the Category list, select **Device**. The **Device** page appears.
4. Click **Device and Pin Options**. The **Device and Pin Options** dialog box appears as shown in Figure 9–2.
5. In the **Device and Pin Options** dialog box, click the **Error Detection CRC** tab.
6. Turn on **Enable error detection CRC**.
7. In the **Divide error check frequency by** box, enter a valid divisor as documented in Table 9–5 on page 9–5.

Figure 10–2 shows the Cyclone IV GX HSSI receiver BSC.

Figure 10–2. HSSI Receiver BSC with IEEE Std. 1149.6 BST Circuitry for the Cyclone IV GX Devices



For more information about Cyclone IV devices user I/O boundary-scan cells, refer to the *IEEE 1149.1 (JTAG) Boundary-Scan Testing for Cyclone III Devices* chapter.

BST Operation Control

Table 10–1 lists the boundary-scan register length for Cyclone IV devices.

Table 10–1. Boundary-Scan Register Length for Cyclone IV Devices (Part 1 of 2)

Device	Boundary-Scan Register Length
EP4CE6	603
EP4CE10	603
EP4CE15	1080
EP4CE22	732
EP4CE30	1632
EP4CE40	1632
EP4CE55	1164
EP4CE75	1314
EP4CE115	1620
EP4CGX15	260
EP4CGX22	494
EP4CGX30 *(1)*	494
EP4CGX50	1006

Table 10–1. Boundary-Scan Register Length for Cyclone IV Devices (Part 2 of 2)

Device	Boundary-Scan Register Length
EP4CGX75	1006
EP4CGX110	1495
EP4CGX150	1495

Note to Table 10–1:

(1) For the F484 package of the EP4CGX30 device, the boundary-scan register length is 1006.

Table 10–2 lists the `IDCODE` information for Cyclone IV devices.

Table 10–2. IDCODE Information for 32-Bit Cyclone IV Devices

Device	IDCODE (32 Bits) (1)			
	Version (4 Bits)	Part Number (16 Bits)	Manufacturer Identity (11 Bits)	LSB (1 Bit) (2)
EP4CE6	0000	0010 0000 1111 0001	000 0110 1110	1
EP4CE10	0000	0010 0000 1111 0001	000 0110 1110	1
EP4CE15	0000	0010 0000 1111 0010	000 0110 1110	1
EP4CE22	0000	0010 0000 1111 0011	000 0110 1110	1
EP4CE30	0000	0010 0000 1111 0100	000 0110 1110	1
EP4CE40	0000	0010 0000 1111 0100	000 0110 1110	1
EP4CE55	0000	0010 0000 1111 0101	000 0110 1110	1
EP4CE75	0000	0010 0000 1111 0110	000 0110 1110	1
EP4CE115	0000	0010 0000 1111 0111	000 0110 1110	1
EP4CGX15	0000	0010 1000 0000 0001	000 0110 1110	1
EP4CGX22	0000	0010 1000 0001 0010	000 0110 1110	1
EP4CGX30 (3)	0000	0010 1000 0000 0010	000 0110 1110	1
EP4CGX30 (4)	0000	0010 1000 0010 0011	000 0110 1110	1
EP4CGX50	0000	0010 1000 0001 0011	000 0110 1110	1
EP4CGX75	0000	0010 1000 0000 0011	000 0110 1110	1
EP4CGX110	0000	0010 1000 0001 0100	000 0110 1110	1
EP4CGX150	0000	0010 1000 0000 0100	000 0110 1110	1

Notes to Table 10–2:

(1) The MSB is on the left.

(2) The `IDCODE` LSB is always 1.

(3) The `IDCODE` is applicable for all packages except for the F484 package.

(4) The `IDCODE` is applicable for the F484 package only.

IEEE Std.1149.6 mandates the addition of two new instructions: `EXTEST_PULSE` and `EXTEST_TRAIN`. These two instructions enable edge-detecting behavior on the signal path containing the AC pins.

Table 1–23 lists the Cyclone IV GX transceiver block AC specifications.

Table 1–23. Transceiver Block AC Specification for Cyclone IV GX Devices *(1), (2)*

Symbol/ Description	Conditions	C6			C7, I7			C8			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
PCIe Transmit Jitter Generation *(3)*											
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	—	—	0.25	—	—	0.25	—	—	0.25	UI
PCIe Receiver Jitter Tolerance *(3)*											
Total jitter at 2.5 Gbps (Gen1)	Compliance pattern	> 0.6			> 0.6			> 0.6			UI
GIGE Transmit Jitter Generation *(4)*											
Deterministic jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.14	—	—	0.14	—	—	0.14	UI
Total jitter (peak-to-peak)	Pattern = CRPAT	—	—	0.279	—	—	0.279	—	—	0.279	UI
GIGE Receiver Jitter Tolerance *(4)*											
Deterministic jitter tolerance (peak-to-peak)	Pattern = CJPAT	> 0.4			> 0.4			> 0.4			UI
Combined deterministic and random jitter tolerance (peak-to-peak)	Pattern = CJPAT	> 0.66			> 0.66			> 0.66			UI

Notes to Table 1–23:

(1) Dedicated `refclk` pins were used to drive the input reference clocks.
(2) The jitter numbers specified are valid for the stated conditions only.
(3) The jitter numbers for PIPE are compliant to the PCIe Base Specification 2.0.
(4) The jitter numbers for GIGE are compliant to the IEEE802.3-2002 Specification.

Core Performance Specifications

The following sections describe the clock tree specifications, PLLs, embedded multiplier, memory block, and configuration specifications for Cyclone IV Devices.

Clock Tree Specifications

Table 1–24 lists the clock tree specifications for Cyclone IV devices.

Table 1–24. Clock Tree Performance for Cyclone IV Devices *(Part 1 of 2)*

Device	Performance								Unit
	C6	C7	C8	C8L *(1)*	C9L *(1)*	I7	I8L *(1)*	A7	
EP4CE6	500	437.5	402	362	265	437.5	362	402	MHz
EP4CE10	500	437.5	402	362	265	437.5	362	402	MHz
EP4CE15	500	437.5	402	362	265	437.5	362	402	MHz
EP4CE22	500	437.5	402	362	265	437.5	362	402	MHz
EP4CE30	500	437.5	402	362	265	437.5	362	402	MHz
EP4CE40	500	437.5	402	362	265	437.5	362	402	MHz

Embedded Multiplier Specifications

Table 1–26 lists the embedded multiplier specifications for Cyclone IV devices.

Table 1–26. Embedded Multiplier Specifications for Cyclone IV Devices

Mode	Resources Used	Performance					Unit
	Number of Multipliers	C6	C7, I7, A7	C8	C8L, I8L	C9L	
9 × 9-bit multiplier	1	340	300	260	240	175	MHz
18 × 18-bit multiplier	1	287	250	200	185	135	MHz

Memory Block Specifications

Table 1–27 lists the M9K memory block specifications for Cyclone IV devices.

Table 1–27. Memory Block Performance Specifications for Cyclone IV Devices

Memory	Mode	Resources Used		Performance					Unit
		LEs	M9K Memory	C6	C7, I7, A7	C8	C8L, I8L	C9L	
M9K Block	FIFO 256 × 36	47	1	315	274	238	200	157	MHz
	Single-port 256 × 36	0	1	315	274	238	200	157	MHz
	Simple dual-port 256 × 36 CLK	0	1	315	274	238	200	157	MHz
	True dual port 512 × 18 single CLK	0	1	315	274	238	200	157	MHz

Configuration and JTAG Specifications

Table 1–28 lists the configuration mode specifications for Cyclone IV devices.

Table 1–28. Passive Configuration Mode Specifications for Cyclone IV Devices *(1)*

Programming Mode	V_{CCINT} Voltage Level (V)	DCLK f_{MAX}	Unit
Passive Serial (PS)	1.0 *(3)*	66	MHz
	1.2	133	MHz
Fast Passive Parallel (FPP) *(2)*	1.0 *(3)*	66	MHz
	1.2 *(4)*	100	MHz

Notes to Table 1–28:

(1) For more information about PS and FPP configuration timing parameters, refer to the *Configuration and Remote System Upgrades in Cyclone IV Devices* chapter.

(2) FPP configuration mode supports all Cyclone IV E devices (except for E144 package devices) and EP4CGX50, EP4CGX75, EP4CGX110, and EP4CGX150 only.

(3) V_{CCINT} = 1.0 V is only supported for Cyclone IV E 1.0 V core voltage devices.

(4) Cyclone IV E devices support 1.2 V V_{CCINT}. Cyclone IV E 1.2 V core voltage devices support 133 MHz DCLK f_{MAX} for EP4CE6, EP4CE10, EP4CE15, EP4CE22, EP4CE30, and EP4CE40 only.